



MOSFET

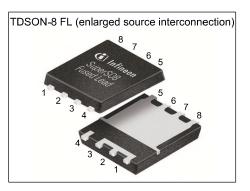
OptiMOS[™] Power-MOSFET, 30 V

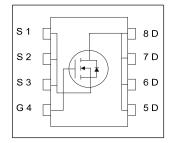
Features

- Optimized for high performance Buck converter
- 175 °C rated
- Very low on-resistance R_{DS(on)} @ V_{GS}=4.5 V
- 100% avalanche tested
- Superior thermal resistance
- N-channel
- Qualified according to JEDEC¹⁾ for target applications
 Pb-free lead plating; RoHS compliant
 Halogen-free according to IEC61249-2-21

Table 1 **Kev Performance Parameters**

Parameter	Value	Unit					
V _{DS}	30	V					
R _{DS(on),max}	1.1	mΩ					
ID	240	A					
Q _{OSS}	40	nC					
Q _G (0V10V)	72	nC					









Type / Ordering Code	Package	Marking	Related Links
BSC011N03LST	PG-TDSON-8 FL	011N03LT	-



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1 Maximum ratings at T_A =25 °C, unless otherwise specified

Table 2 **Maximum ratings**

Parameter	0		Values			
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Continuous drain current ¹⁾	ID	- - - -	- - - -	240 170 213 150 39	A	$V_{GS}=10 \text{ V}, T_{C}=25 \text{ °C} \\ V_{GS}=10 \text{ V}, T_{C}=100 \text{ °C} \\ V_{GS}=4.5 \text{ V}, T_{C}=25 \text{ °C} \\ V_{GS}=4.5 \text{ V}, T_{C}=100 \text{ °C} \\ V_{GS}=10 \text{ V}, T_{A}=25 \text{ °C}, R_{thJA}=50 \text{ K/W}^{2)} $
Pulsed drain current ³⁾	I _{D,pulse}	-	-	960	A	<i>T</i> _C =25 °C
Avalanche current, single pulse ⁴⁾	IAS	-	-	50	A	<i>T</i> _c =25 °C
Avalanche energy, single pulse	EAS	-	-	190	mJ	I _D =50 A, <i>R</i> _{GS} =25 Ω
Gate source voltage ⁵⁾	V _{GS}	-20	-	20	V	-
Power dissipation	P _{tot}	-	-	115 3.0	W	$T_{\rm C}$ =25 °C $T_{\rm A}$ =25 °C, $R_{\rm thJA}$ =50 K/W ²⁾
Operating and storage temperature	$T_{\rm j}, T_{\rm stg}$	-55	-	175	°C	-

2 **Thermal characteristics**

Table 3 **Thermal characteristics**

Devementer	Symbol	Values			11	Nata / Taat Canditian
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Thermal resistance, junction - case, bottom	R _{thJC}	-	-	1.3	K/W	-
Thermal resistance, junction - case, top	R _{thJC}	-	-	20	K/W	-
Device on PCB, 6 cm ² cooling area ²⁾	R _{thJA}	-	-	50	K/W	-

¹⁾ Rating refers to the product only with datasheet specified absolute maximum values, maintaining case temperature at 25°C. For higher case temperature please refer to Diagram 2. De-rating will be required based on the actual

environmental conditions. ²⁾ Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm2 (one layer, 70 μ m thick) copper area for drain connection. PCB is vertical in still air. ³⁾ See Diagram 3 for more detailed information

 ⁴⁾ See Diagram 13 for more detailed information
 ⁵⁾ The negative rating is for low duty cycle pulse occurrence. No continuous rating is implied



3 Electrical characteristics at *T*_j=25 °C, unless otherwise specified

Table 4 **Static characteristics**

Parameter	Symphol		Values			Note / Toot Condition
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Drain-source breakdown voltage	V _{(BR)DSS}	30	-	-	V	V _{GS} =0 V, <i>I</i> _D =1 mA
Gate threshold voltage	V _{GS(th)}	1.2	-	2	V	V _{DS} =V _{GS} , <i>I</i> _D =250 μA
Zero gate voltage drain current	I _{DSS}	-	0.1 10	1 100	μA	V _{DS} =30 V, V _{GS} =0 V, T _j =25 °C V _{DS} =30 V, V _{GS} =0 V, T _j =125 °C
Gate-source leakage current	I _{GSS}	-	10	100	nA	V _{GS} =20 V, V _{DS} =0 V
Drain-source on-state resistance	R _{DS(on)}	-	1.1 0.9	1.4 1.1	mΩ	V _{GS} =4.5 V, <i>I</i> _D =30 A V _{GS} =10 V, <i>I</i> _D =30 A
Gate resistance ¹⁾	R _G	0.3	0.6	1.2	Ω	-
Transconductance	g_{fs}	85	170	-	S	V _{DS} >2 I _D R _{DS(on)max} , I _D =30 A

Table 5Dynamic characteristics

Parameter	Course had		Values			
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Input capacitance ¹⁾	Ciss	-	4700	6300	pF	V _{GS} =0 V, V _{DS} =15 V, <i>f</i> =1 MHz
Output capacitance ¹⁾	Coss	-	1500	2000	pF	V _{GS} =0 V, V _{DS} =15 V, <i>f</i> =1 MHz
Reverse transfer capacitance	C _{rss}	-	220	-	pF	V _{GS} =0 V, V _{DS} =15 V, <i>f</i> =1 MHz
Turn-on delay time	t _{d(on)}	-	6.7	-	ns	$V_{\rm DD}$ =15 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =30 A, $R_{\rm G,ext}$ =1.6 Ω
Rise time	t _r	-	8.8	-	ns	$V_{\rm DD}$ =15 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =30 A, $R_{\rm G,ext}$ =1.6 Ω
Turn-off delay time	t _{d(off)}	-	37	-	ns	$V_{\rm DD}$ =15 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =30 A, $R_{\rm G,ext}$ =1.6 Ω
Fall time	t _f	-	6.2	-	ns	$V_{\rm DD}$ =15 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =30 A, $R_{\rm G,ext}$ =1.6 Ω

Table 6 Gate charge characteristics²⁾

Parameter	Cumula a l	Values				
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Gate to source charge ¹⁾	Q _{gs}	-	11	15	nC	V_{DD} =15 V, I_{D} =30 A, V_{GS} =0 to 4.5 V
Gate charge at threshold	Q _{g(th)}	-	7.5	-	nC	V_{DD} =15 V, I_{D} =30 A, V_{GS} =0 to 4.5 V
Gate to drain charge ¹⁾	Q _{gd}	-	10.3	13	nC	V_{DD} =15 V, I_{D} =30 A, V_{GS} =0 to 4.5 V
Switching charge	Qsw	-	14	-	nC	V_{DD} =15 V, I_{D} =30 A, V_{GS} =0 to 4.5 V
Gate charge total ¹⁾	Qg	-	36	48	nC	V_{DD} =15 V, I_{D} =30 A, V_{GS} =0 to 4.5 V
Gate plateau voltage	V _{plateau}	-	2.4	-	V	V_{DD} =15 V, I_{D} =30 A, V_{GS} =0 to 4.5 V
Gate charge total ¹⁾	Qg	-	72	96	nC	V_{DD} =15 V, I_{D} =30 A, V_{GS} =0 to 10 V
Gate charge total, sync. FET	Qg(sync)	-	29	-	nC	V _{DS} =0.1 V, V _{GS} =0 to 4.5 V
Output charge ¹⁾	Qoss	-	40	53	nC	V _{DD} =15 V, V _{GS} =0 V

 $^{1)}$ Defined by design. Not subject to production test $^{2)}$ See "Gate charge waveforms" for parameter definition

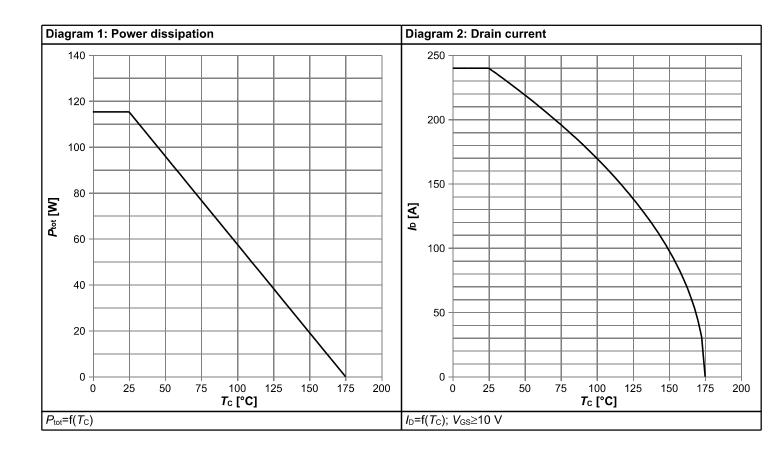


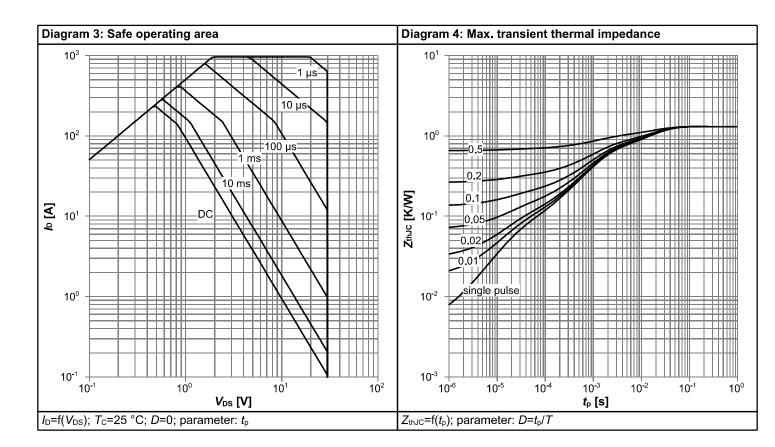
Table 7Reverse diode

Peremeter	Symbol	Values			11	Note / Test Condition
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Diode continuous forward current	ls	-	-	115	А	<i>T</i> _C =25 °C
Diode pulse current	I _{S,pulse}	-	-	960	А	<i>T</i> _C =25 °C
Diode forward voltage	V _{SD}	-	0.8	1	V	V _{GS} =0 V, <i>I</i> _F =30 A, <i>T</i> _j =25 °C
Reverse recovery charge	Qrr	-	20	-	nC	V _R =15 V, <i>I</i> _F = <i>I</i> _S , d <i>i</i> _F /d <i>t</i> =400 A/µs

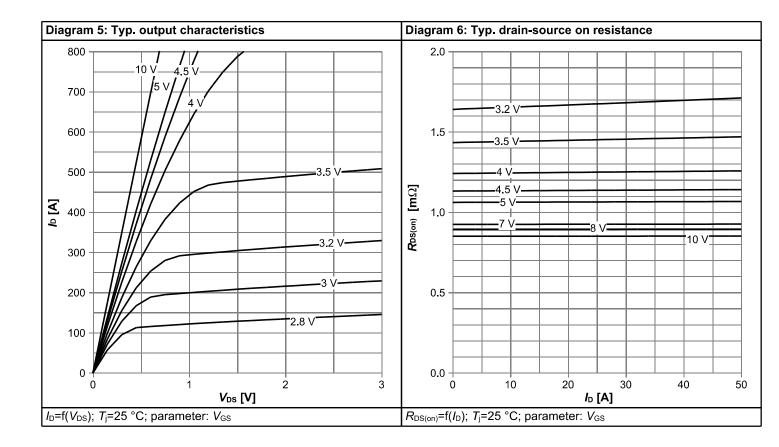


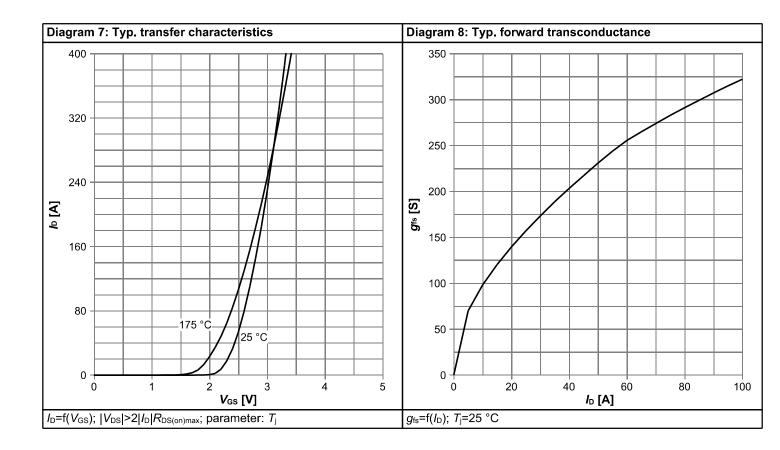
4 Electrical characteristics diagrams



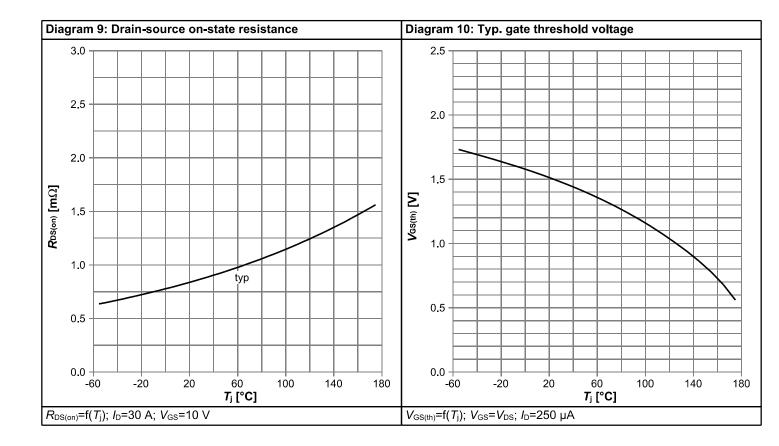


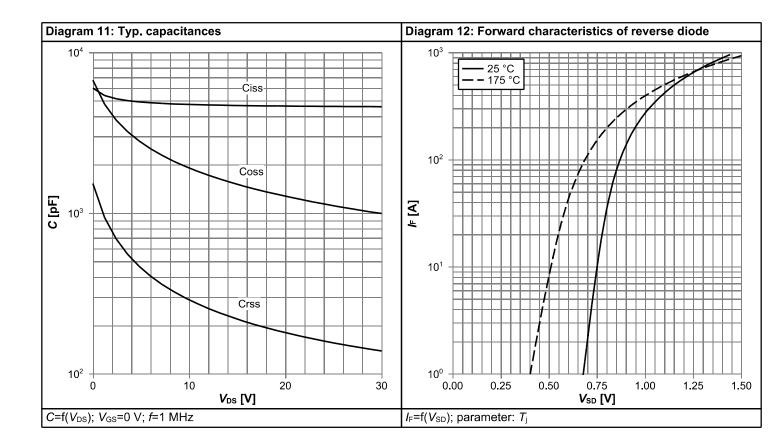




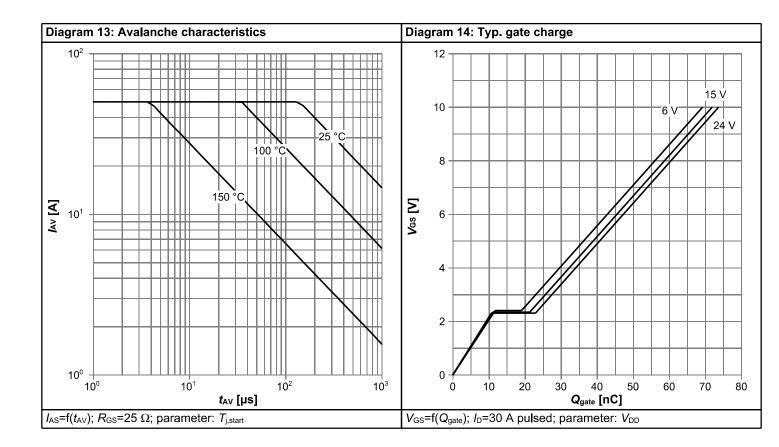


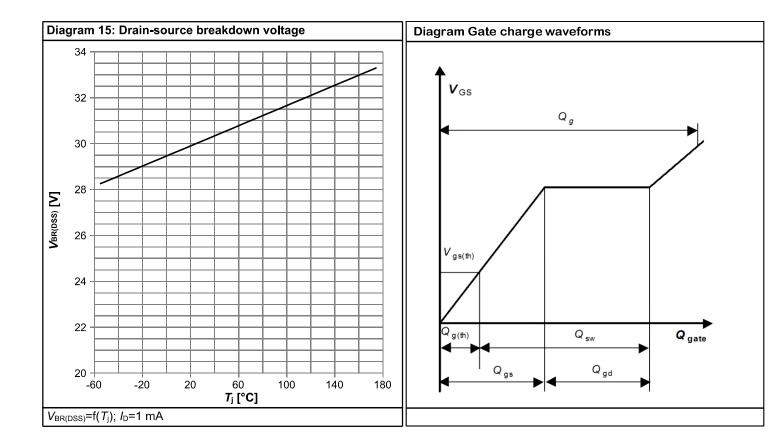






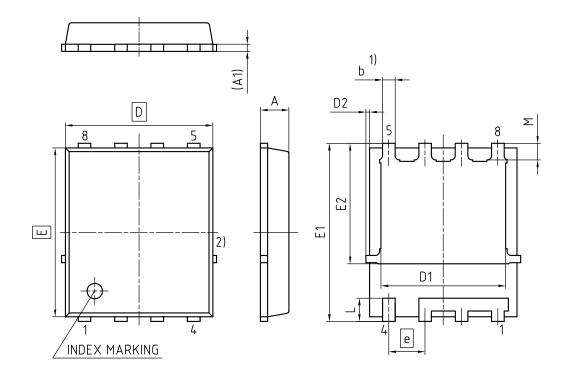








5 Package Outlines



 EXCLUDING MOLD FLASH
 REMOVAL ON MOLD GATE INTRUSION 0.1 MM PROTRUSION 0.1 MM
 LEAD LENGTH UP TO ANTI FLASH LINE
 ALL METAL SURFACES ARE PLATED, EXCEPT AREA OF CUT

DIMENSION	MILLIMETERS						
DIMENSION	MIN.	MAX.					
A	0.90	1.20					
A1	0.15	0.35					
b	0.26	0.54					
D	4.80	5.35					
D1	3.70	4.40					
D2	0.02	0.23					
E	5.70	6.10					
E1	5.90	6.42					
E2	3.88	4.42					
е	1.27						
L	0.69 0.90						
M	0.45	0.69					

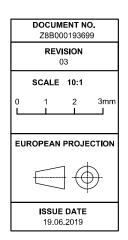


Figure 1 Outline PG-TDSON-8 FL, dimensions in mm



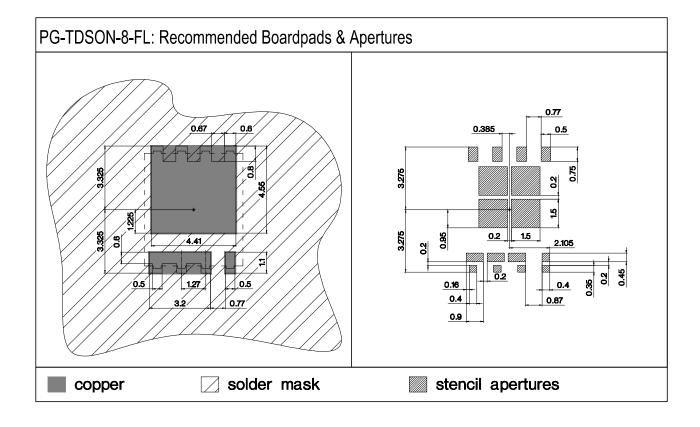
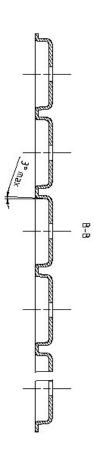


Figure 2 Outline Boardpads (TDSON-8 FL)





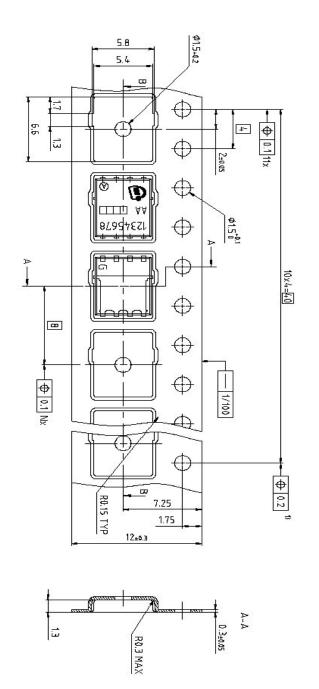


Figure 3 Outline Tape (TDSON-8 FL)



Revision History

BSC011N03LST

Revision: 2020-11-12, Rev. 2.3

Previous F	Previous Revision						
Revision	Date Subjects (major changes since last revision)						
2.0	2017-03-01	Release of final version					
2.1	2017-10-30	Insert footnote under Vgs					
2.2	2019-10-01	Update package drawings					
2.3	2020-11-12	Update current rating					

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